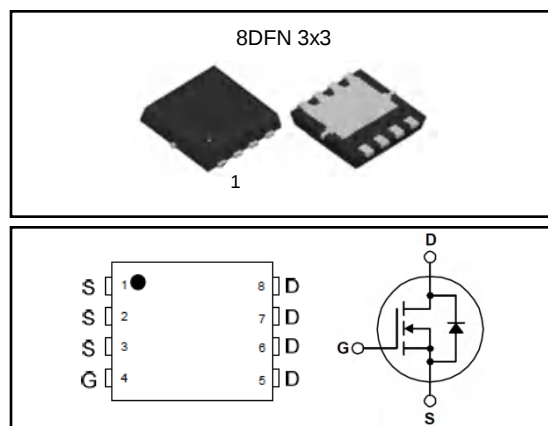


HRLFS190N03K

30V N-Channel Trench MOSFET

FEATURES

- ❑ $BV_{DSS} = 30\text{ V}$
- ❑ $I_D = 28\text{ A}$
- ❑ Unrivalled Gate Charge : 12 nC (Typ.)
- ❑ Lower $R_{DS(ON)}$: 16 mΩ (Typ.) @ $V_{GS}=10\text{V}$
- ❑ Lower $R_{DS(ON)}$: 20 mΩ (Typ.) @ $V_{GS}=4.5\text{V}$
- ❑ 100% Avalanche Tested



Absolute Maximum Ratings $T_J=25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter		Value	Units
V_{DSS}	Drain-Source Voltage		30	V
V_{GS}	Gate-Source Voltage		± 20	V
I_D	Drain Current	$T_C = 25^\circ\text{C}$	28	A
		$T_C = 100^\circ\text{C}$	18	A
I_{DM}	Pulsed Drain Current	(Note 1)	62	A
E_{AS}	Single Pulsed Avalanche Energy	(Note 2)	110	mJ
P_D	Power Dissipation	$T_C = 25^\circ\text{C}$	23	W
		$T_A = 25^\circ\text{C}$	1.67	W
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to +150	$^\circ\text{C}$

Thermal Resistance Characteristics

Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	--	5.4	$^\circ\text{C/W}$
$R_{\theta JA}$	Junction-to-Ambient (steady state)	--	75	$^\circ\text{C/W}$

Electrical Characteristics $T_J=25\text{ }^{\circ}\text{C}$ unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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On Characteristics

V_{GS}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	1.0	--	2.4	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{ V}, I_D = 10\text{ A}$	--	16	19	m Ω
		$V_{GS} = 4.5\text{ V}, I_D = 9\text{ A}$	--	20	25	m Ω
g_{FS}	Forward Transconductance	$V_{DS} = 5, I_D = 10\text{ A}$	--	10	--	S

Off Characteristics

BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	30	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24\text{ V}, V_{GS} = 0\text{ V}$	--	--	1	μA
		$V_{DS} = 24\text{ V}, T_J = 125\text{ }^{\circ}\text{C}$	--	--	100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$	--	--	± 100	nA

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS} = 15\text{ V}, V_{GS} = 0\text{ V},$ $f = 1.0\text{ MHz}$	--	590	--	pF
C_{oss}	Output Capacitance		--	90	--	pF
C_{rss}	Reverse Transfer Capacitance		--	65	--	pF
R_g	Gate Resistance	$V_{GS} = 0\text{ V}, V_{DS} = 0\text{ V}, f = 1\text{ MHz}$	--	2.5	--	Ω

Switching Characteristics

$t_{d(on)}$	Turn-On Time	$V_{DS} = 15\text{ V}, I_D = 10\text{ A},$ $R_G = 6\text{ }\Omega$	--	12	--	ns
t_r	Turn-On Rise Time		--	15	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	45	--	ns
t_f	Turn-Off Fall Time		--	12	--	ns
$Q_{g(10V)}$	Total Gate Charge	$V_{DS} = 24\text{ V}, I_D = 10\text{ A},$ $V_{GS} = 10\text{ V}$	--	12	--	nC
$Q_{g(4.5V)}$	Total Gate Charge		--	6	--	nC
Q_{gs}	Gate-Source Charge		--	2.2	--	nC
Q_{gd}	Gate-Drain Charge		--	1.9	--	nC

Source-Drain Diode Maximum Ratings and Characteristics

I _S	Continuous Source-Drain Diode Forward Current		--	--	28	A
I _{SM}	Pulsed Source-Drain Diode Forward Current		--	--	62	
V _{SD}	Source-Drain Diode Forward Voltage	I _S = 10 A, V _{GS} = 0 V	--	--	1.3	V
trr	Reverse Recovery Time	I _S = 10 A, V _{GS} = 0 V di _F /dt = 100 A/μs	--	20	--	ns
Qrr	Reverse Recovery Charge		--	10	--	nC

Notes :

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. $L=1\text{ mH}, I_{AS}=6\text{ A}, V_{DD}=25\text{ V}, R_G=25\text{ }\Omega$, Starting $T_J=25\text{ }^{\circ}\text{C}$

Typical Characteristics

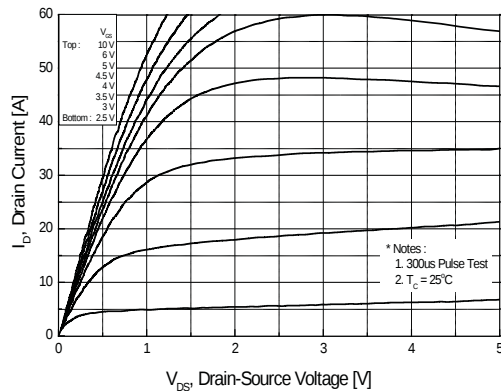


Figure 1. On Region Characteristics

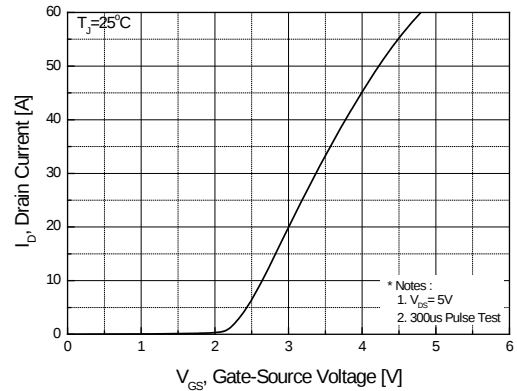


Figure 2. Transfer Characteristics

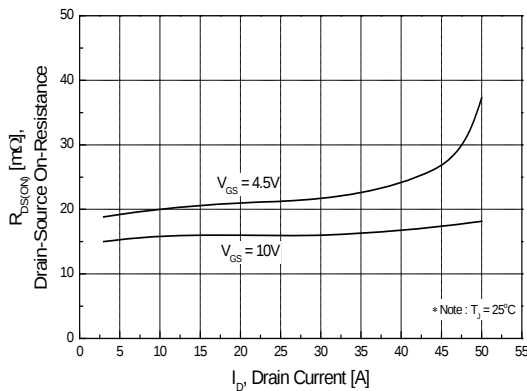


Figure 3. On Resistance Variation vs Drain Current and Gate Voltage

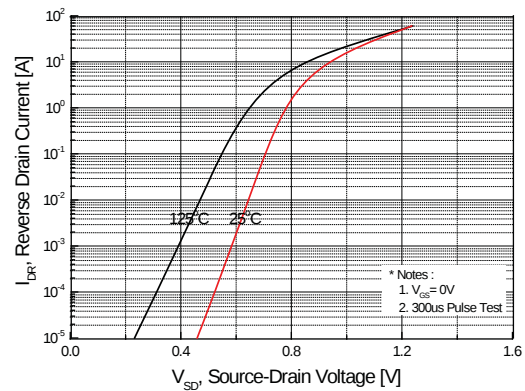


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

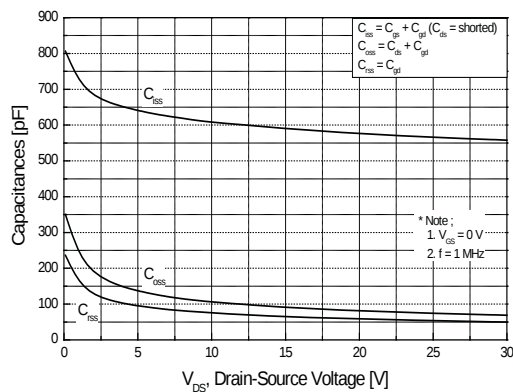


Figure 5. Capacitance Characteristics

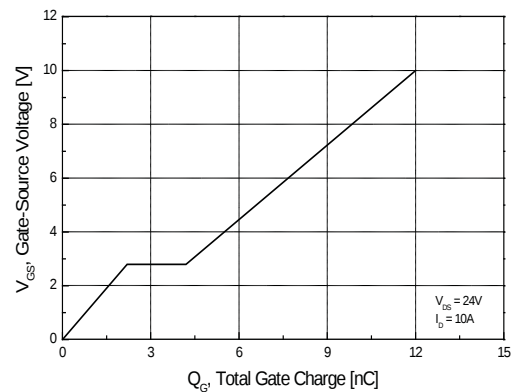


Figure 6. Gate Charge Characteristics

Typical Characteristics (continued)

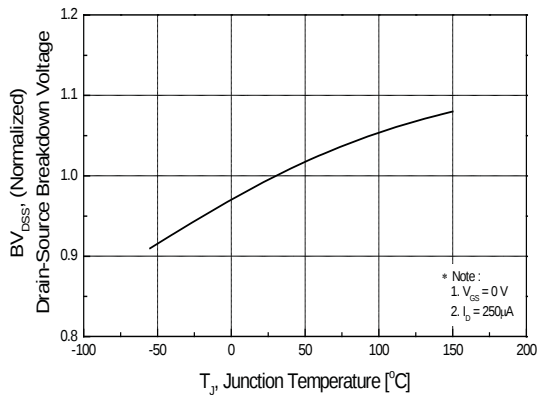


Figure 7. Breakdown Voltage Variation vs Temperature

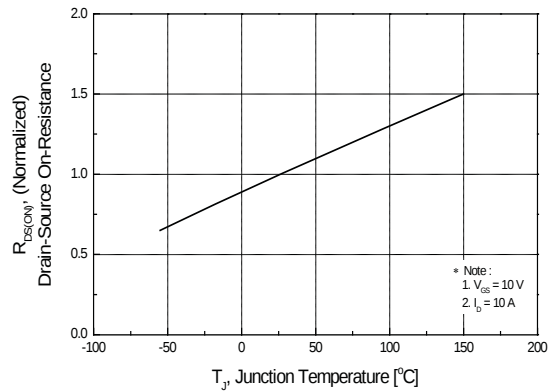


Figure 8. On-Resistance Variation vs Temperature

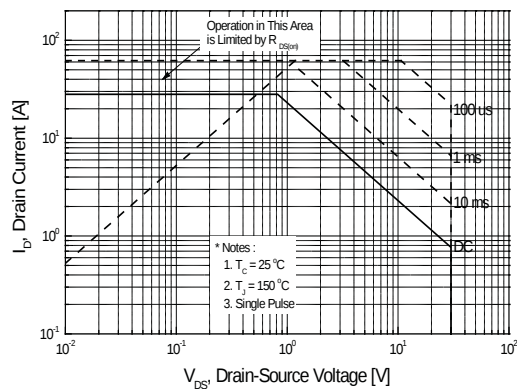


Figure 9. Maximum Safe Operating Area

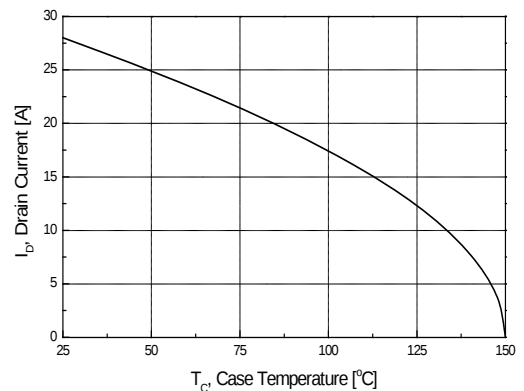


Figure 10. Maximum Drain Current vs Case Temperature

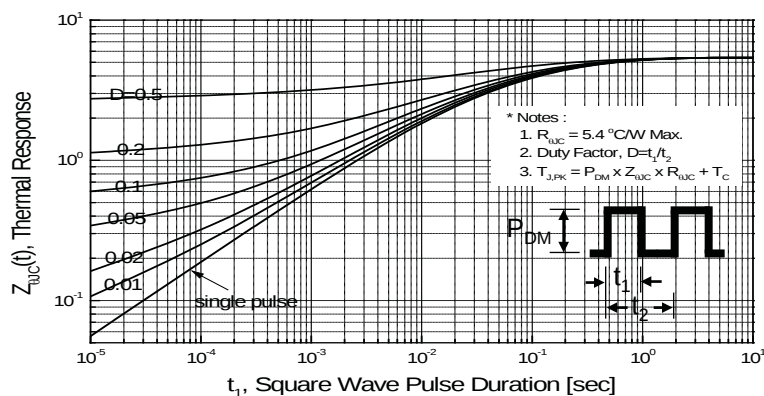


Figure 11. Transient Thermal Response Curve

Fig 12. Gate Charge Test Circuit & Waveform

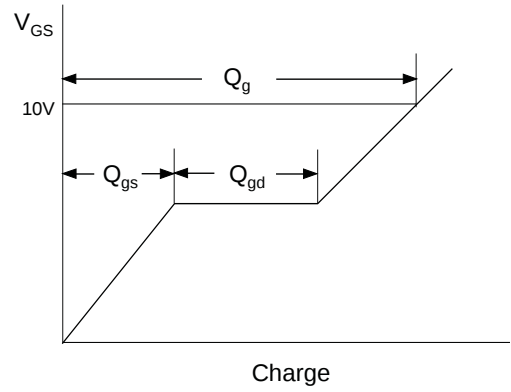
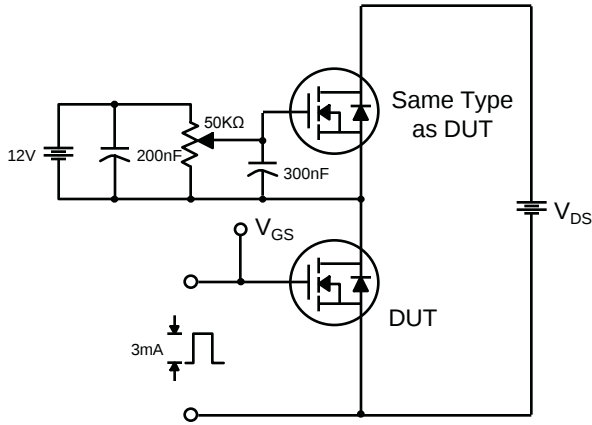


Fig 13. Resistive Switching Test Circuit & Waveforms

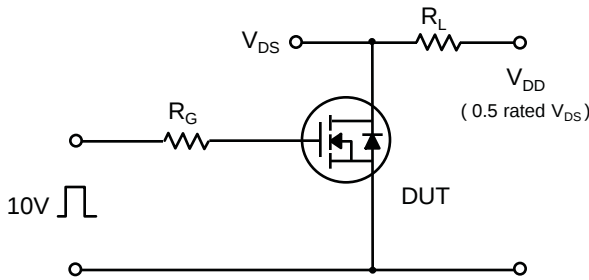


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

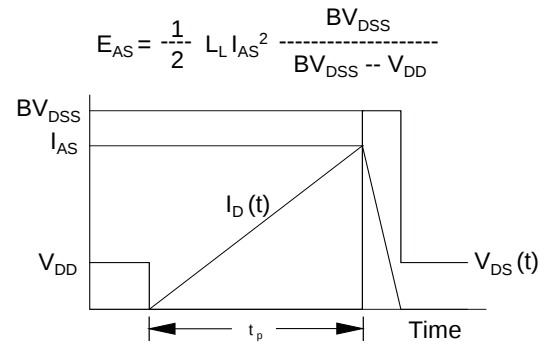
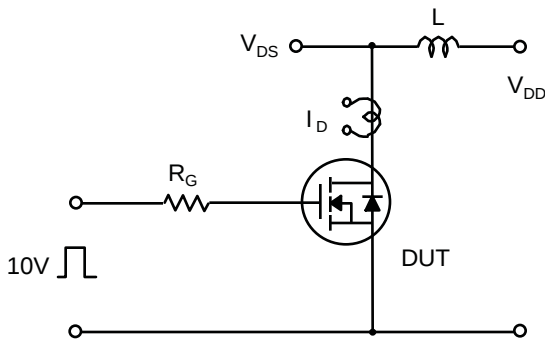
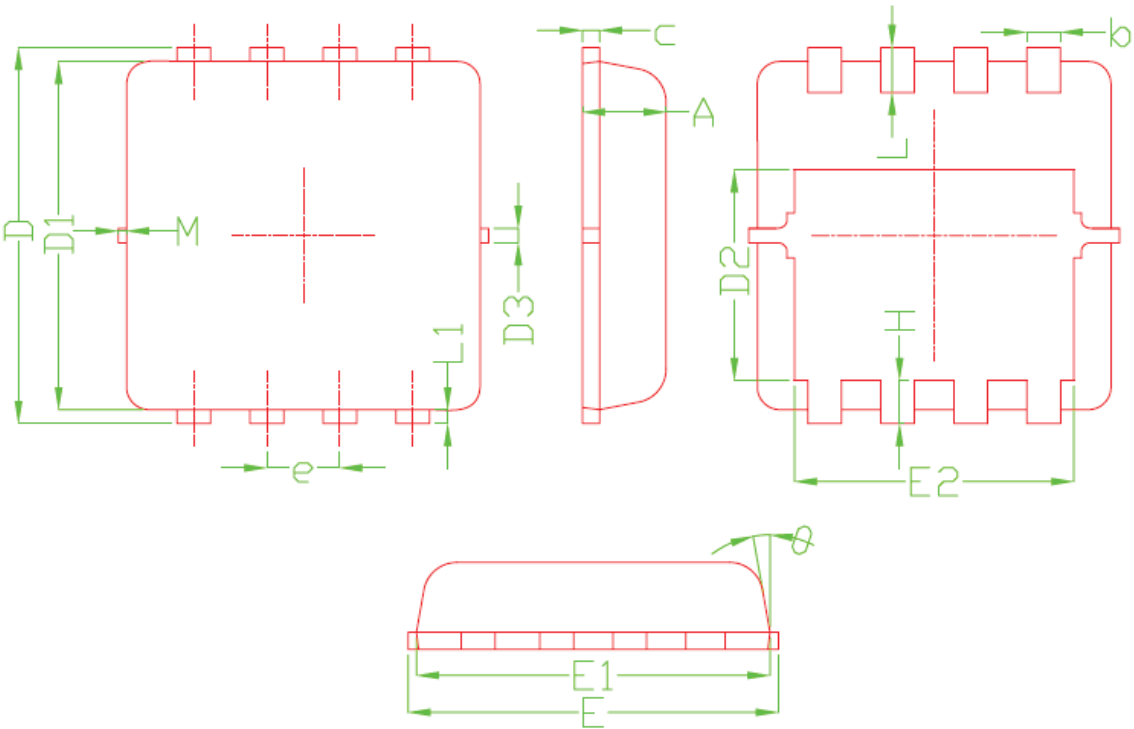


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



Package Dimension

8DFN 3x3



SYMBOL	DIMENSIONAL REOMTS		
	MIN	NOM	MAX
A	0.70	0.75	0.80
b	0.25	0.30	0.35
c	0.10	0.15	0.25
D	3.25	3.35	3.45
D1	3.00	3.10	3.20
D2	1.78	1.88	1.98
D3	---	0.13	---
E	3.20	3.30	3.40
E1	3.00	3.15	3.20
E2	2.39	2.49	2.59
e	0.65BSC		
H	0.30	0.39	0.50
L	0.30	0.40	0.50
L1	---	0.13	---
θ	---	10°	12°
M	*	*	0.15
* Not specified			

